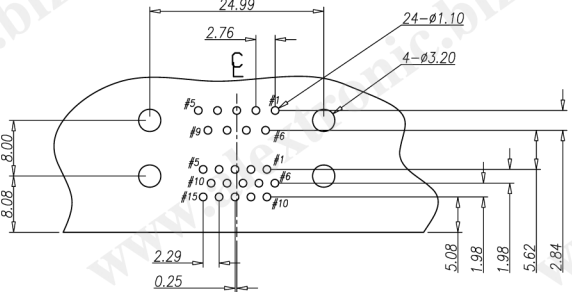
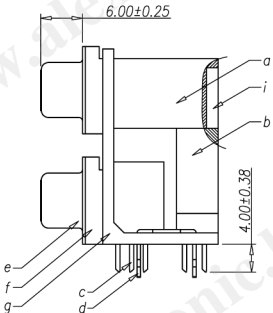
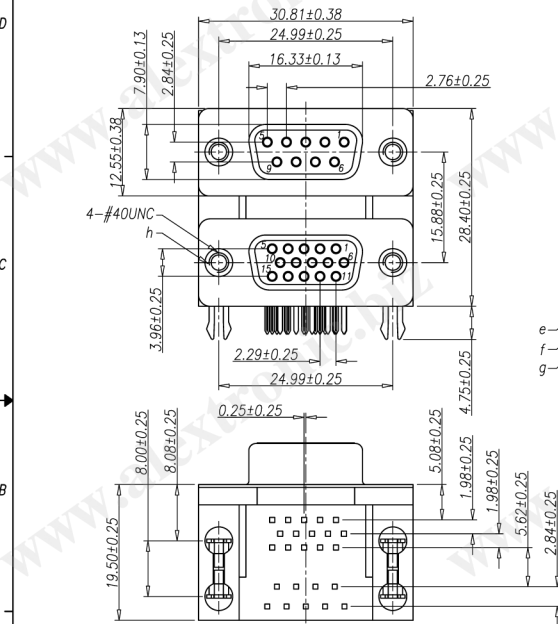


CATEGORY	DESCRIPTION	P/N #
CONNECTOR	D-SUB 0.20"(5.08) FOOTPRINT 9F/15F HIGH DENSITY CONNECTOR DUAL PORT	DBOF1F-51170-0001

REV.	ECN NO	DESCRIPTION	REVISED	DATE
A01	1	New Release	Luguan	2009.07.14

SPECIFICATIONS

- CONTACT CURRENT RATING:3 Amperes.
- DIELECTRIC WITHSTANDING VOLTAGE:AC 1000/60sec.r.m.s.
- INSULATION RESISTANCE:5000 Medohms MIN.AT DC 500V.
- CONTACT RESISTANCE:25 Milliohms MAX.
- TEMPERATURE:-55°C TO +105°C.
- GROUNDING SCREW TORQUE:3Kg MIN.
- SOLDER HEAT RESISTANCE:WAVE SOLDERING 260° 10sec.
- GREEN PRODUCT IDENTIFICATION LABEL IN PACKING: **G.P. PASS**



Recommend PCB Layout
(Jack Top View)
Tolerance: ±0.05mm
Recommend PCB Thickness: 1.6mm

i	Cover A	1	PBT UL94V-0	Black	
h	Rivet	4	Brass	Ni Plating	
g	Frame	2	Zinc Alloy	Ni Plating	
f	Housing B	1	PBT UL94V-0	Black	
e	Shell	2	Steel	Ni Plating	
d	Board Lock	2	Brass, T=0.5mm	Tin Plating	
c	Terminal	24	Brass	Gold Flash Plating	
b	Cover B	1	PBT UL94V-0	Black	
a	Housing A	1	PBT UL94V-0	Black	
NO.	PART NAME	Q'TY	MATERIAL	PLATING & COLOR	Remark

Product Drawing			
ALEXTRONIC			
SCALE: 1/1	UNIT: mm	DWG. NO:	
SIZE: A3	PAGE: 1 OF 1	REV: A01	WI-061-494
APPROVED BY	CHECKED BY	PREPARED BY	
WYX	Pengjie	Luguan	
CUSTOMER COPY			

UNLESS OTHERWISE SPECIFIED TOLERANCES
DECIMALS: X :±0.5 X.X :±2° X.XX :±0.3 X.X.X :±1° X.XX.X :±0.2